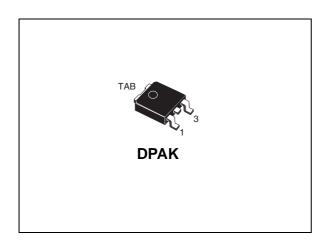
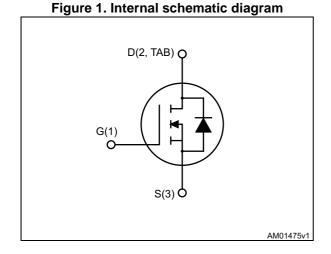


STD85N10F7AG

Automotive-grade N-channel 100 V, 0.0085 Ω typ., 70 A STripFET™ F7 Power MOSFET in a DPAK package

Datasheet - production data





Features

Order code	V _{DS}	R _{DS(on)} max	I _D	P _{TOT}
STD85N10F7AG	100 V	0.010 Ω	70 A	85 W

- Designed for automotive applications and AEC-Q101 qualified
- Among the lowest R_{DS(on)} on the market
- Excellent figure of merit (FoM)
- Low C_{rss}/C_{iss} ratio for EMI immunity
- · High avalanche ruggedness

Applications

· Switching applications

Description

This N-channel Power MOSFET utilizes STripFET™ F7 technology with an enhanced trench gate structure that results in very low onstate resistance, while also reducing internal capacitance and gate charge for faster and more efficient switching.

Table 1. Device summary

Order code	Marking	Package	Packing
STD85N10F7AG	85N10F7	DPAK	Tape and reel

Contents STD85N10F7AG

Contents

1	Electrical ratings
2	Electrical characteristics
	2.1 Electrical characteristics (curves)
3	Test circuits
4	Package information
	4.1 DPAK (TO-252) type A2 package information
	4.2 Packing information
5	Revision history15



STD85N10F7AG Electrical ratings

1 Electrical ratings

Table 2. Absolute maximum ratings

Symbol	Parameter	Value	Unit
V _{DS}	Drain-source voltage	100	V
V _{GS}	Gate-source voltage	± 20	V
	Drain current (continuous) at T _C = 25 °C	70	Α
I _D	Drain current (continuous) at T _C = 100 °C	48	A
I _{DM} ⁽¹⁾	Drain current (pulsed)	280	Α
P _{TOT}	Total dissipation at T _C = 25 °C	85	W
T _{stg}	Storage temperature	- 55 to 175	°C
Tj	Max. operating junction temperature	- 55 10 175	C

^{1.} Pulse width limited by safe operating area.

Table 3. Thermal data

Symbol	Parameter	Value	Unit
R _{thj-pcb}	Thermal resistance junction-pcb max	50	°C/W
R _{thj-case}	Thermal resistance junction-case max	1.76	C/VV

Electrical characteristics STD85N10F7AG

2 Electrical characteristics

(T_C = 25 °C unless otherwise specified)

Table 4. Static

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
V _{(BR)DSS}	Drain-source breakdown voltage	$I_D = 250 \mu\text{A}, V_{GS} = 0$	100			V
1	Zero gate voltage	V _{DS} = 100 V			1	
DSS	drain current ($V_{GS} = 0$)	V _{DS} = 100 V, T _C =125 °C			100	μA
I _{GSS}	Gate-body leakage current (V _{DS} = 0)	V _{GS} = 20 V			100	nA
V _{GS(th)}	Gate threshold voltage	$V_{DS} = V_{GS}, I_{D} = 250 \mu A$	2.5	3.5	4.5	V
R _{DS(on)}	Static drain-source on-resistance	I _D = 40 A, V _{GS} =10 V		0.0085	0.010	Ω

Table 5. Dynamic

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
C _{iss}	Input capacitance		-	3100	-	
C _{oss}	Output capacitance	$V_{DS} = 50 \text{ V, f} = 1 \text{ MHz,}$	-	700	-	pF
C _{rss}	Reverse transfer capacitance	$V_{GS} = 0$	-	45	-	'
Qg	Total gate charge	V _{DD} = 50 V, I _D = 70 A,	-	45	-	
Q _{gs}	Gate-source charge	V _{GS} = 10 V	-	18	-	nC
Q _{gd}	Gate-drain charge	(see Figure 14)	-	13	-	

Table 6. Switching times

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
t _{d(on)}	Turn-on delay time		-	19	-	
t _r	Rise time	$V_{DD} = 50 \text{ V}, I_D = 40 \text{ A},$ $R_G = 4.7 \Omega, V_{GS} = 10 \text{ V}$	-	32	-	nc
t _{d(off)}	Turn-off delay time	(see Figure 15 and Figure 18)	-	36	-	ns
t _f	Fall time	,	-	13	-	

Table 7. Source drain diode

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
I _{SD}	Source-drain current		-		70	Α
I _{SDM} ⁽¹⁾	Source-drain current (pulsed)		-		280	Α
V _{SD} (2)	Forward on voltage	I _{SD} = 70 A, V _{GS} = 0	-		1.1	V
t _{rr}	Reverse recovery time	I _{SD} = 70 A, di/dt = 100 A/μs	-	70		ns
Q _{rr}	Reverse recovery charge	$V_{DD} = 80 \text{ V, T}_{i} = 150 ^{\circ}\text{C}$	-	125		nC
I _{RRM}	Reverse recovery current	(see Figure 18)	-	3.6		Α

^{1.} Pulse width limited by safe operating area.

^{2.} Pulsed: pulse duration = 300 μ s, duty cycle 1.5%

Electrical characteristics STD85N10F7AG

10ms

V_{DS}(V)

2.1 Electrical characteristics (curves)

Figure 2. Safe operating area

GIPD220720131539FSR

(A)

100

Operation for the area is 100 μs

1 Tj=175°C Tc=25°C 1ms

Figure 3. Thermal impedance

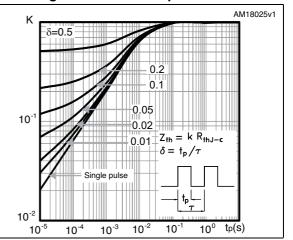


Figure 4. Output characteristics

Sinlge pulse

10

AM15971v1

VGS=10 V

9V

250

8V

100

100

6V

50

0

2

4

6

8

VDS(V)

Figure 5. Transfer characteristics

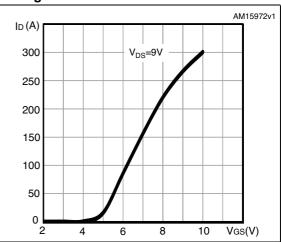
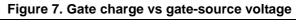
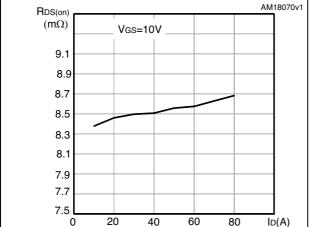
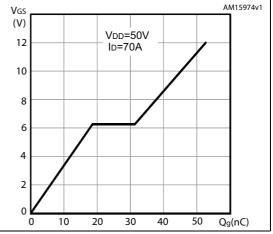


Figure 6. Static drain-source on-resistance





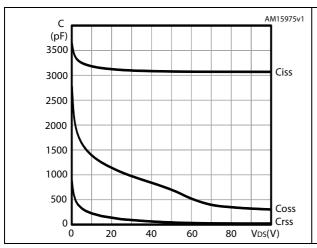


577

6/16

Figure 8. Capacitance variations

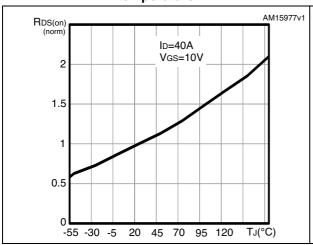
Figure 9. Normalized gate threshold voltage vs temperature



AM15976v1 VGS(th) (norm) 1.2 $ID=250\mu A$ 0.8 0.6 0.4 0.2 0 -55 -30 -5 20 45 70 95 120 TJ(°C)

Figure 10. Normalized on-resistance vs temperature

Figure 11. Source-drain diode forward characteristics



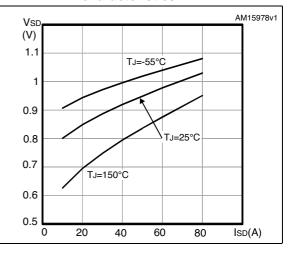
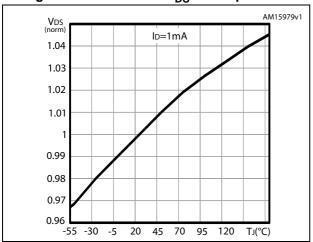


Figure 12. Normalized V_{DS} vs temperature



Test circuits STD85N10F7AG

3 Test circuits

Figure 13. Switching times test circuit for resistive load

Figure 14. Gate charge test circuit

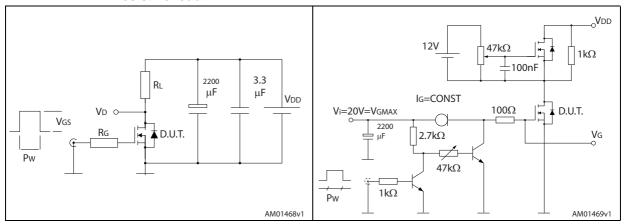


Figure 15. Test circuit for inductive load switching and diode recovery times

Figure 16. Unclamped inductive load test circuit

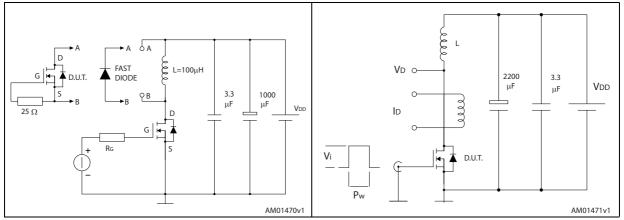
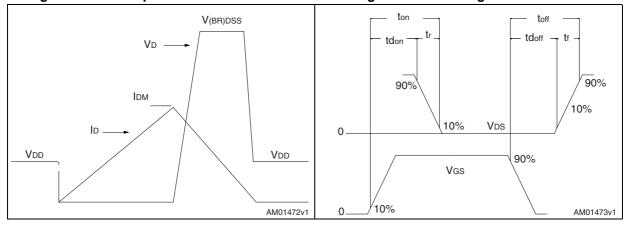


Figure 17. Unclamped inductive waveform

Figure 18. Switching time waveform



57/

4 Package information

In order to meet environmental requirements, ST offers these devices in different grades of ECOPACK[®] packages, depending on their level of environmental compliance. ECOPACK[®] specifications, grade definitions and product status are available at: www.st.com. ECOPACK[®] is an ST trademark.



Package information STD85N10F7AG

4.1 DPAK (TO-252) type A2 package information

Ε THERMAL PAD c2 E1 L2 D A 1 <u>b(</u>2x) R С SEATING PLANE *V2* 0,25 0068772_type-A2_rev19

Figure 19. DPAK (TO-252) type A2 package outline

577

Table 8. DPAK (TO-252) type A2 mechanical data

Dim		mm	
Dim.	Min.	Тур.	Max.
А	2.20		2.40
A1	0.90		1.10
A2	0.03		0.23
b	0.64		0.90
b4	5.20		5.40
С	0.45		0.60
c2	0.48		0.60
D	6.00		6.20
D1	4.95	5.10	5.25
Е	6.40		6.60
E1	5.10	5.20	5.30
е	2.16	2.28	2.40
e1	4.40		4.60
Н	9.35		10.10
L	1.00		1.50
L1	2.60	2.80	3.00
L2	0.65	0.80	0.95
L4	0.60		1.00
R		0.20	
V2	0°		8°

Package information STD85N10F7AG

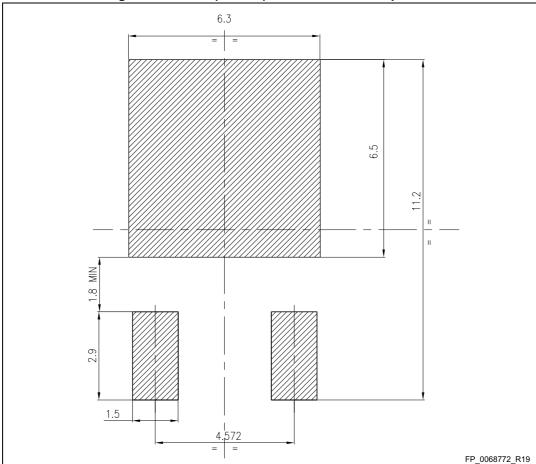


Figure 20. DPAK (TO-252) recommended footprint (a)

12/16 DocID027030 Rev 2

a. All dimensions are in millimeters

4.2 Packing information

Figure 21. Tape outline

AM08852v1

Package information STD85N10F7AG

REEL DIMENSIONS 40mm min. Access hole At slot location В D С Tape slot in core for G measured at hub Full radius tape start 25 mm min. width AM08851v2

Figure 22. Reel outline

Table 9. DPAK (TO-252) tape and reel mechanical data

	Таре			Reel	
Dim.	m	nm	Dim.	m	nm
Dilli.	Min.	Max.		Min.	Max.
A0	6.8	7	А		330
В0	10.4	10.6	В	1.5	
B1		12.1	С	12.8	13.2
D	1.5	1.6	D	20.2	
D1	1.5		G	16.4	18.4
Е	1.65	1.85	N	50	
F	7.4	7.6	Т		22.4
K0	2.55	2.75			
P0	3.9	4.1		Base qty.	2500
P1	7.9	8.1		Bulk qty.	2500
P2	1.9	2.1			
R	40				
Т	0.25	0.35			
W	15.7	16.3			

STD85N10F7AG Revision history

5 Revision history

Table 10. Document revision history

Date	Revision	Changes
21-Oct-2014	1	First release.
26-May-2015	2	Text and formatting edits throughout document. Promoted document from "preliminary data" to "production data" Updated device package information.

IMPORTANT NOTICE - PLEASE READ CAREFULLY

STMicroelectronics NV and its subsidiaries ("ST") reserve the right to make changes, corrections, enhancements, modifications, and improvements to ST products and/or to this document at any time without notice. Purchasers should obtain the latest relevant information on ST products before placing orders. ST products are sold pursuant to ST's terms and conditions of sale in place at the time of order acknowledgement.

Purchasers are solely responsible for the choice, selection, and use of ST products and ST assumes no liability for application assistance or the design of Purchasers' products.

No license, express or implied, to any intellectual property right is granted by ST herein.

Resale of ST products with provisions different from the information set forth herein shall void any warranty granted by ST for such product.

ST and the ST logo are trademarks of ST. All other product or service names are the property of their respective owners.

Information in this document supersedes and replaces information previously supplied in any prior versions of this document.

© 2015 STMicroelectronics - All rights reserved

577